

Description

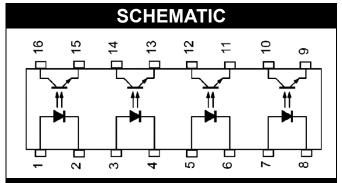
The PS2801x-4 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic SO16 package with different lead forming options. With the robust coplanar double mold structure, PS2801x-4 series provide the most stable isolation feature.

Features

- High isolation 3750 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free
- MSL class 1

Applications

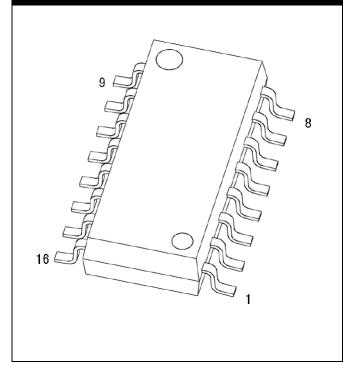
- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



PIN DEFINITION

1,3,5,7 : Anode 2,4,6,8 : Cathode 9,11,13,15: Emitter 10,12,14,16: Collector

PACKAGE OUTLINE





ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	VALUE	UNIT	NOTE		
INPUT						
Forward Current	l _F	60	mA			
Peak Forward Current	IFP	1	А	1		
Reverse Voltage	VR	6	V			
Input Power Dissipation	Pı	100	mW			
OUTPUT						
Collector - Emitter Voltage	Vceo	80	V			
Emitter - Collector Voltage	VECO	7	V			
Collector Current	Ic	50	mA			
Output Power Dissipation	Po	150	mW			
COMMON						
Total Power Dissipation	Ptot	200	mW			
Isolation Voltage	Viso	3750	Vrms	2		
Operating Temperature	Topr	-55~110	°C			
Storage Temperature	Tstg	-55~125	°C			
Soldering Temperature	Tsol	260	°C			

Note 1. 100µs pulse, 100Hz frequency

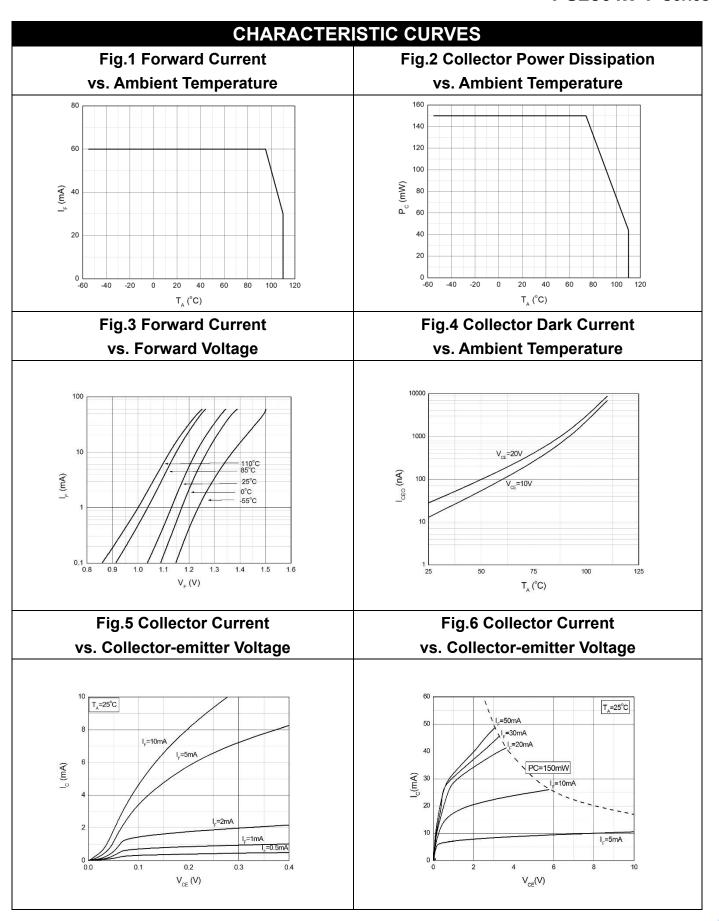
Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$

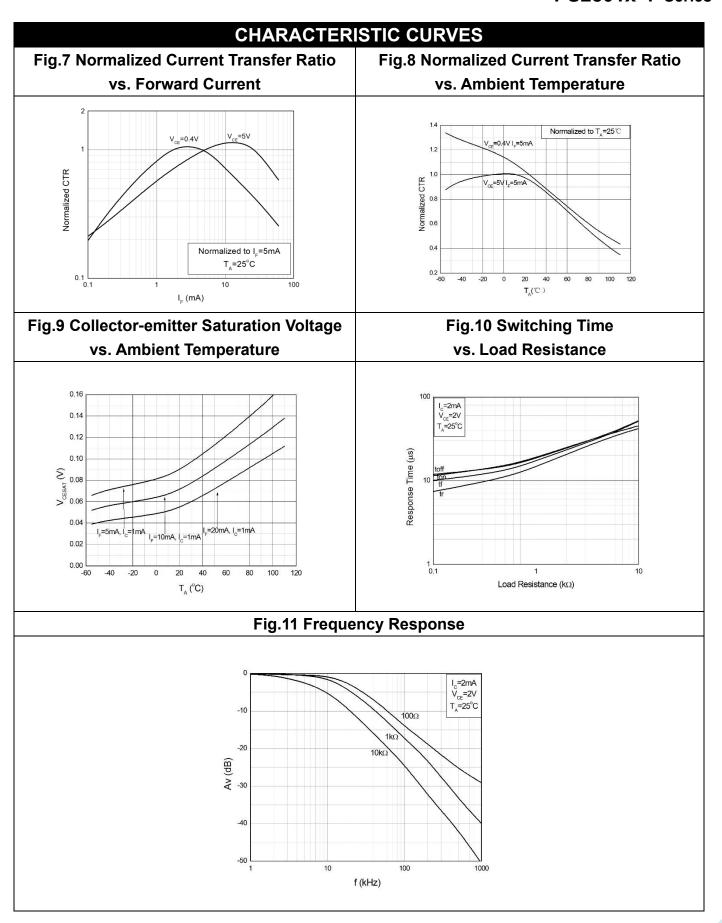


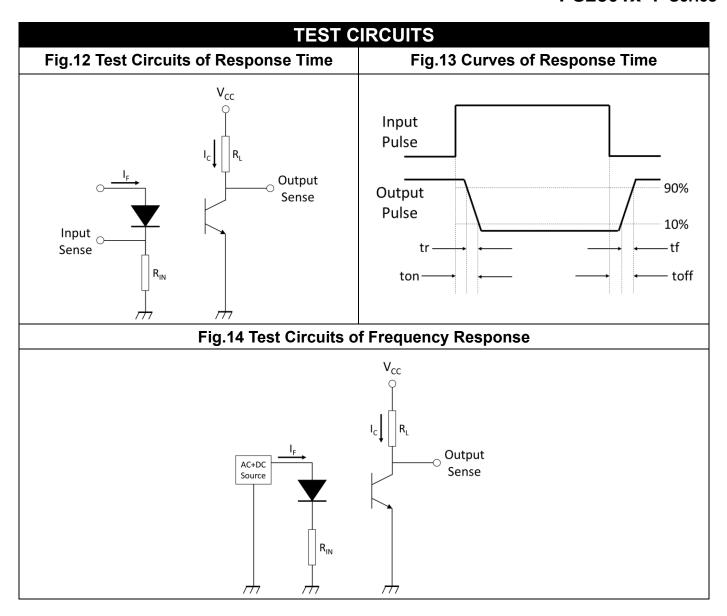
	ELECT	RICAL OF	PTICA	L CHA	RAC	TER	ISTICS at Ta=25°C	
PARA	METER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
INPUT								
Forward	d Voltage	V_{F}	-	ı	1.4	V	IF=10mA	
Reverse	e Current	I_R	-	ı	10	μA	VR=6V	
Input Ca	pacitance	Cin	-	10	-	pF	V=0, f=1kHz	
OUTPUT								
Collector D	Oark Current	ICEO	-	-	100	nA	VCE=20V, IF=0	
	or-Emitter vn Voltage	BVceo	80	-	-	V	IC=0.1mA, IF=0	
	Collector vn Voltage	BV _{ECO}	7	-	-	V	IE=0.1mA, IF=0	
		TR	ANSFE	R CHA	RACT	ERIS	TICS	
	PS2801-4		80	ı	600			
Current	PS2801C-4		100	-	400			
Transfer		CTR				%	IF=5mA, VCE=5V	
Ratio								
	or-Emitter on Voltage	V _{CE(sat)}	-	0.1	0.2	V	IF=10mA, IC=1mA	
Isolation I	Resistance	R _{ISO}	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating C	apacitance	Сю	-	0.4	1	pF	V=0, f=1MHz	
Response	Time (Rise)	tr	-	3	18	μs	VCE=2V, IC=2mA	3
Response	Time (Fall)	tf	-	4	18	μs	RL=100Ω	3
Cut-off F	requency	fc	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω,-3dB	4

Note 3. Fig.12&13

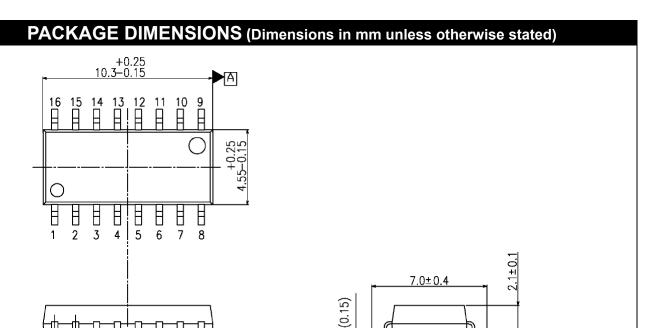
Note 4. Fig.14







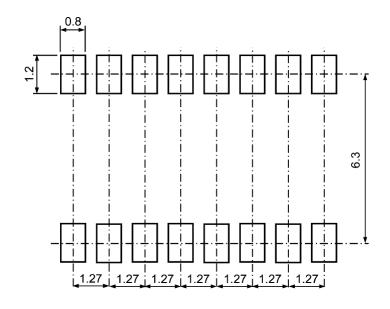




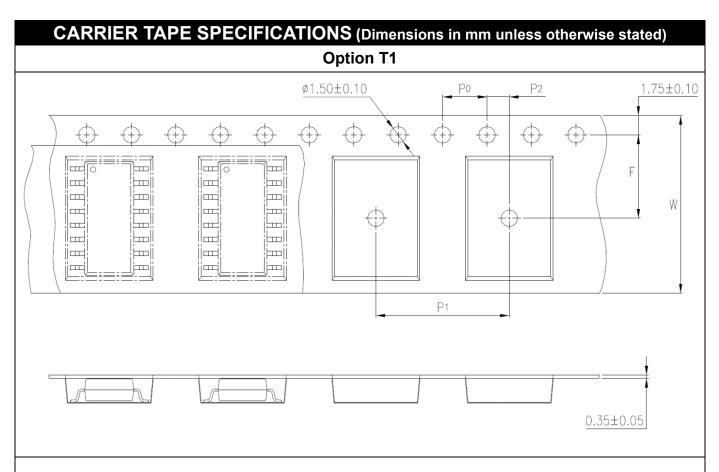
0.5min

(0.1)

Recommended Solder Mask (Dimensions in mm unless otherwise stated)

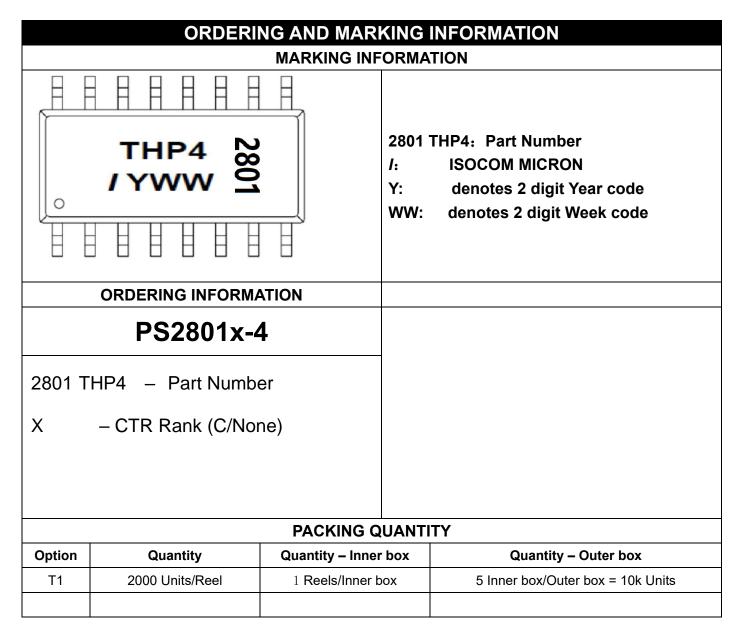




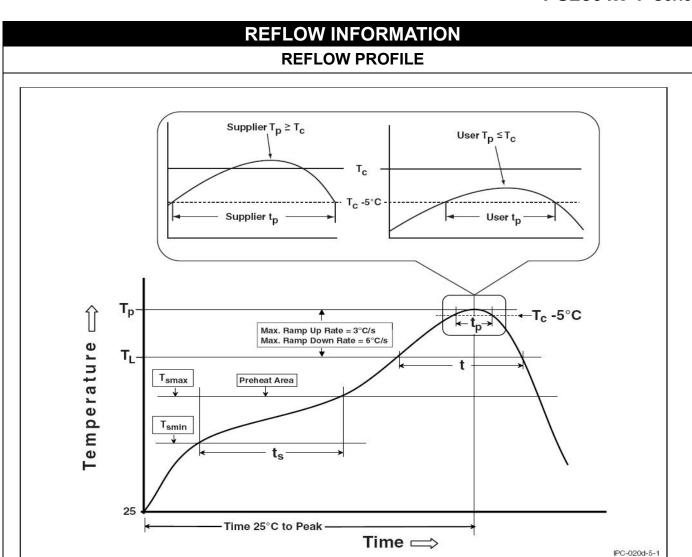


Description	Symbol	Dimension	
		mm (inch)	
Tape Width	W	16 ± 0.3 (0.63)	
Pitch of Sprocket Holes	P0	4 ± 0.1 (0.15)	
Distance of Compartment to	F	7.5 ± 0.1 (0.295)	
Sprocket Holes	P2	2 ± 0.1 (0.079)	
Distance of Compartment to	P1	12 ± 0.1 (0.47)	
Compartment			

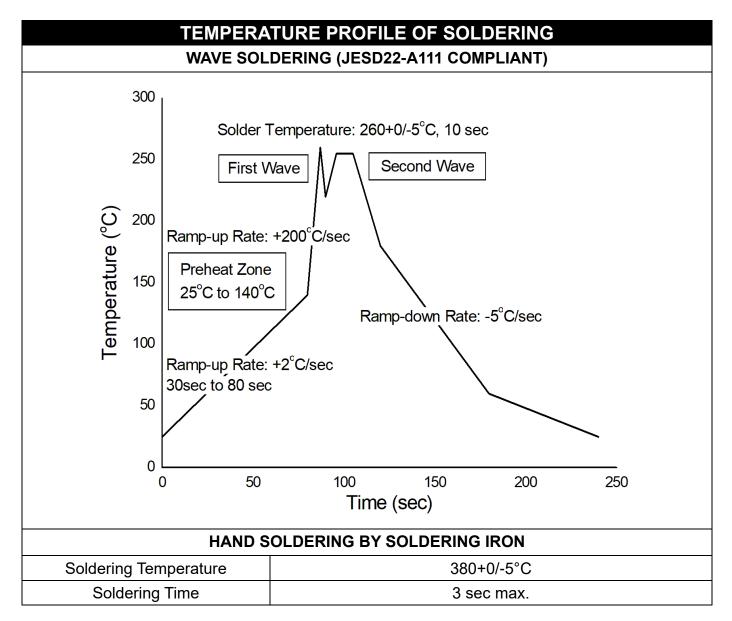








	1	
Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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